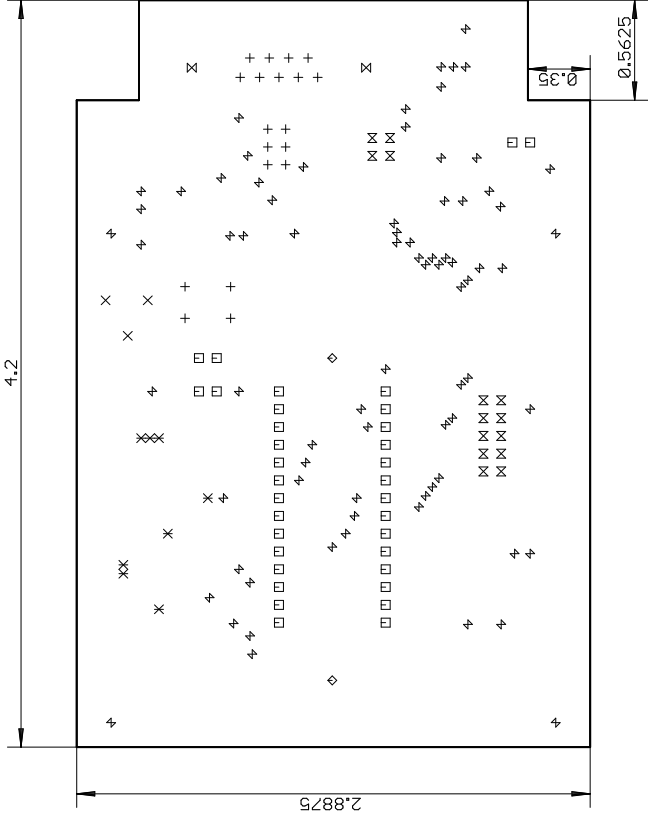


FABRICATION DRAWING



DRILL PLAN				
SYM	SIZE	TOL.	CNT	PLATE
+	0.016 in	+/-0.003 in	73	Yes
X	0.024 in	+/-0.003 in	8	Yes
□	0.032 in	+/-0.003 in	34	Yes
◇	0.036 in	+/-0.003 in	14	Yes
+	0.040 in	+/-0.003 in	19	Yes
X	0.056 in	+/-0.003 in	3	Yes
◇	0.066 in	+/-0.003 in	2	NO
+	0.125 in	+/-0.003 in	4	NO
Σ	0.128 in	+/-0.003 in	2	Yes

TOTAL 159 153

NOTES:

1. PRINTED CIRCUIT BOARD MADE FROM NEMA GRADE FR-4 EPOXY LAMINATE WITH 0.5 OUNCE COPPER PLATING AND .062 THICKNESS.
2. ALL DIMENSIONS ARE GIVEN IN INCHES.
3. CIRCUIT PATHS ARE FOR REFERENCE ONLY.
4. HOLE SIZES SHOWN ARE FINISHED DIAMETERS AFTER PLATING.
5. BOARD PLATED USING REFLOW OR SIMILAR METHOD.
6. APPLY GREEN SOLDER MASK ON PLATED SURFACES USING LIQUID PHOTO IMAGEABLE MASK OR WET FILM SR1000 EPOXY. EQUIVALENT WET OR DRY FILM MAY BE USED.
8. THE FOLLOWING INFORMATION APPLIES TO THIS BOARD:
 - * 2 COPPER LAYERS.
 - * .062 BOARD THICKNESS.
 - * SILKSCREEN TOP AND BOTTOM SIDE USING WHITE INK.

ISSUE	KG4LNE	2013 ©
DRAWN R.STARR	TITLE GE-FLASH-USB	REV B
CHECKED R.STARR	DATE 6/18/2013 11:29:30 PM	DRG N° GEF-USB.2XX
APPROVED R.STARR	FILE: GEF-USB-B	PAGE: